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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KENZO KITAZAKI	03/30/2018
TAKEHIKO KAI	03/30/2018
MASAYA SHIMAMURA	03/30/2018
MIKIO AOKI	04/05/2018
JIN MIKATA	04/05/2018
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RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15935829

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	84774.3405US
NAME OF SUBMITTER:	MAIKO KUWADA
SIGNATURE:	/Maiko Kuwada/
DATE SIGNED:	04/09/2018
	This document serves as an Oath/Declaration (37 CFR 1.63).

PAIENI REEL: 045483 FRAME: 0220

Total Attachments: 2

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PATENT REEL: 045483 FRAME: 0221

ATTORNEY DOCKET NO.: 84774.3405US SOLE/JOINT INVENTION (U.S. Rights Only)

COMBINED DECLARATION AND ASSIGNMENT FOR UTILITY APPLICATION			
Title of Invention	METHOD OF MANUFACTURING ELECTRONIC COMPONENT MODULE		
A s a balannua	DECLARATION		
As a below named inventor, I/we hereby declare that: This declaration is directed to: The attached application, or			
United States application or PCT international application number <u>15/935829</u> filed on <u>March 26, 2018</u> .			
The above-ide	ntified application was made or authorized to be made by me/us.		
I/we have revi	ewed and understand the contents of the above-identified application, including the claims, as my amendment specifically referred to above.		
I/we acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to mc/us to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT International filing date of the continuation-in-part application.			
I/we believe the application.	nat I am/we are the original inventor(s) or original joint inventor(s) of a claimed invention in the		
I/we hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.			
ASSIGNMENT			
WHEREAS, TAIYO YUDEN CO., LTD., a corporation of Japan, whose post office address is 7-19 Kyobashi 2-chome, Chuo-ku, Tokyo, 104-0031, Japan, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;			
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/WE have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;			

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AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration,

communicate with Assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.			
AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Power of Attorney in this application, to insert here in parenthesis (Application No, filed) the filing date and application number of said application when known.			
IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).			
Legal Name of Sole or First Inventor			
Kenzo Kitazaki			
Signature	Date		
Kenzo KITAZAKI	March 30, 2018		
Legal Name of Second Inventor Takehiko Kai			
Signature	Date		
Takehiko KAI	March 30,2018		
Legal Name of Third Inventor Masaya Shimamura			
Massya Phimamura	Date March 30, 2018		
Legal Name of Fourth Inventor Mikio Aoki			
Signature Min arlin	Date April . 5 , >0/8		
Legal Name of Fifth Inventor Jin Mikata			
Signature Miket	Date April 5, 2018		
Legal Name of Sixth Inventor Taiji Ito			
Signature	Date		
Tarii Ito	April, 5, 2018		